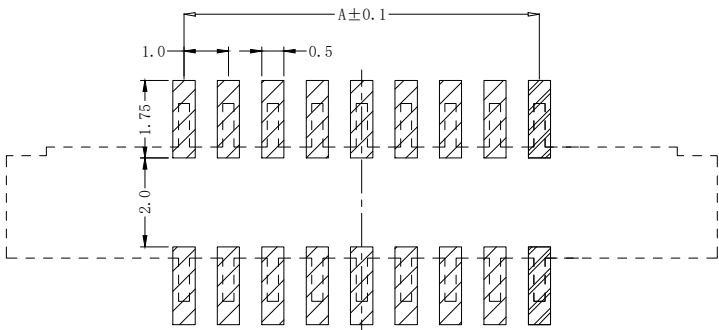
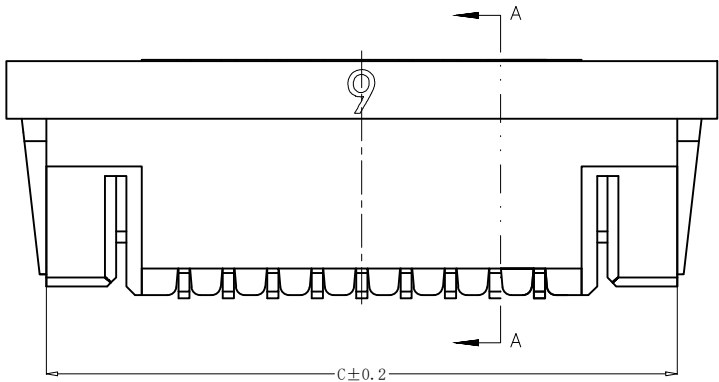
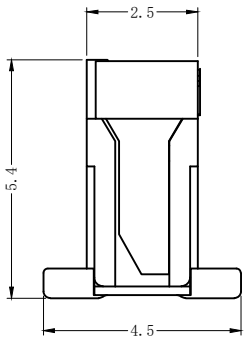
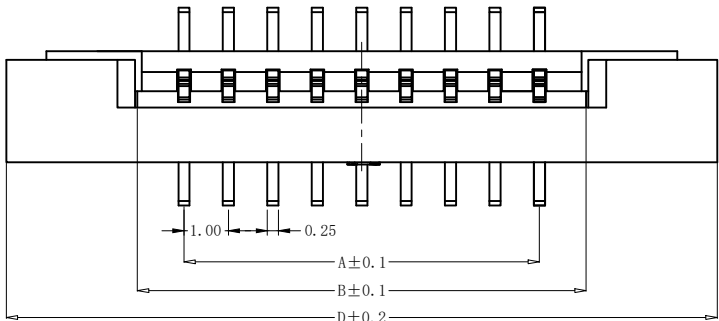


R o H S

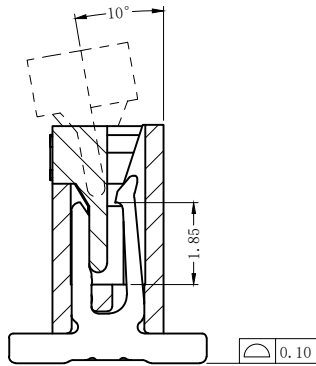
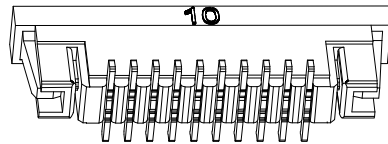


PCB LAYOUT

技术要求 (Technical Index):

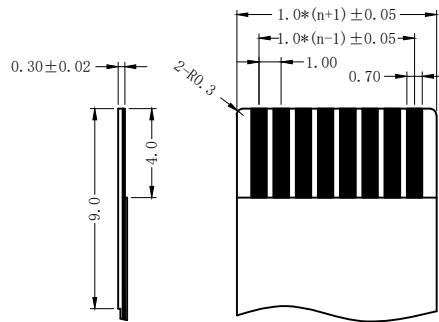
- 材质与表面处理 (Material And Finish):
基座 (Housing) and 盖子 (Cover): LCP UL94V-0 Nature Or Black;
端子 (Terminal): Phosphor Copper Au/Sn Plated;
焊片 (Solder): Copper Alloy Au/Sn Plated;
- 工作温度 (Temperature range): $-25^{\circ}\text{C} \sim +85^{\circ}\text{C}$.
- 额定电压 (Rated voltage): 50V, AC/DC.
- 额定电流: 0.5A, AC/DC.
- 接触电阻 (Contact resistance): $\leq 20\text{m}\Omega$.
- 绝缘电阻 (Insulation resistance): $\geq 800\text{M}\Omega$.
- 耐电压 (Withstanding Voltage): 500V AC/minute.

REV.	ECN NO.	LOCAS.	DESCRIPTION	DATE	DESIGN
A			NEW DRAWING	22.12.01	Jenply



SECTION A-A

孔位	A	B	C	D
4	3	5.15	9.20	11.10
5	4	6.15	10.20	12.10
7	6	8.15	12.20	14.10
9	8	10.15	14.20	16.10
11	10	12.15	16.20	18.10
13	12	14.15	18.20	20.10
17	16	18.15	22.20	24.10
19	18	20.15	24.20	26.10
21	20	22.15	26.20	28.10
23	22	24.15	28.20	30.10
27	26	28.15	32.20	34.10
31	30	32.15	36.20	38.10
32	31	33.15	37.20	39.10
33	32	34.15	38.20	40.10
34	33	35.15	39.20	41.10
35	34	36.15	40.20	42.10
36	35	37.15	41.20	43.10



PROPER CABLE (SCALE 2:1)

DESIGN:	Jenply	QWYCONN® 深圳市启崴源电子有限公司 SHENZHEN QIWEIYUAN ELECTRONIC CO., LTD.			
CHECK:	Ke Tian				
APPROVED:	Youquan Xu	TITLE: 1.0mm FPC (B型) 立贴式一字型			
DIM	TOL	DIM	TOL	PART NO. 1.0K-BT-nPB-***	
X.	±0.25	X°.	±3.0°		
X.X	±0.20	X.X°			
X.XX	±0.15	X.XX°			
X.XXX		X.XXX°			
REV.	A	SCALE:	N/A	UNIT: mm	SHEET: 1/1